# SiHF22N60E

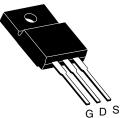


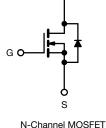


# **E Series Power MOSFET**

PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.18
Q <sub>g</sub> max. (nC)	86	
Q <sub>gs</sub> (nC)	11	
Q <sub>gd</sub> (nC)	24	
Configuration	Sing	le

## TO-220 FULLPAK





### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N60E-E3
Lead (Pb)-free and Halogen-free	SiHF22N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	600	V
Gate-Source Voltage			V <sub>GS</sub>	± 30	v
Continuous Drain Current (T, = 150 °C) <sup>e</sup>	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	21	
Continuous Drain Current $(T_j = 150 \text{ C})^2$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		13	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56	
Linear Derating Factor				0.28	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	367	mJ
Maximum Power Dissipation			PD	35	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	$T_J = 1$	125 °C	d\//dt	70	V/ns
Reverse Diode dV/dt <sup>d</sup>		dV/dt	11	V/ns	
Soldering Recommendations (Peak temperature) <sup>c</sup>	for	10 s		300	°C
Mounting Torque	M3 s	screw		0.6	Nm

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.1 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C.

e. Limited by maximum junction temperature.

S16-1084-Rev. J, 06-Jun-16

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65			°C (M)	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.6			°C/W			
			•					
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 2	250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$		to 25 °C, I		-	0.71	-	V/°(
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> = 2		2	-	4	V
	00(0)		$V_{GS} = \pm 20$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		-	-	± 1	μA
Zero Gate Voltage Drain Current			= 600 V, V <sub>GS</sub>		-	-	1	
	I <sub>DSS</sub>	-		$V_{\rm GS} = 0 \text{ V}, \text{ T}_{\rm J} = 125 \text{ °C}$		-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		<sub>0</sub> = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub> =	5 A	-	6.4	-	S
Dynamic		•	-		<u>.</u>	<u>.</u>		•
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	1920	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 100$ \	Ι,	-	90	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz		-	6	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>		( )		-	73	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$ V_{DS} = 0$ V	/ to 480 V, \	V <sub>GS</sub> = 0 V	-	263	-	
Total Gate Charge	Qg				-	57	86	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 11 A	A, V <sub>DS</sub> = 480 V	-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	24	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	36	
Rise Time	t <sub>r</sub>	V <sub>PP</sub> -	- 380 V In -	- 11 Δ	-	27	54	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 380 V, I <sub>D</sub> = 11 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω		-	66	99	ns	
Fall Time	t <sub>f</sub>		-		-	35	70	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.3	0.77	1.2	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the			-	-	21	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers p - n junction			-	-	56	Δ
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °0	C, I <sub>S</sub> = 11 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	344	-	n
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> = I <sub>S</sub> 100 A/us M	= 11 A,	-	5.3	-	μ
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	28	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. C<sub>oss(tr)</sub> is a fixed capacitance that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 % to 80 % V<sub>DSS</sub>.



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

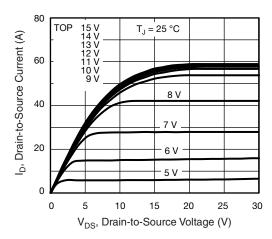


Fig. 1 - Typical Output Characteristics

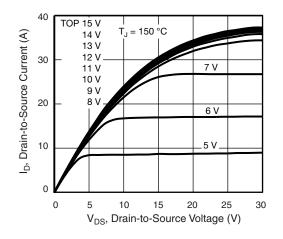


Fig. 2 - Typical Output Characteristics

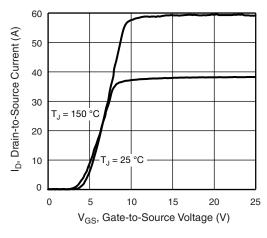


Fig. 3 - Typical Transfer Characteristics

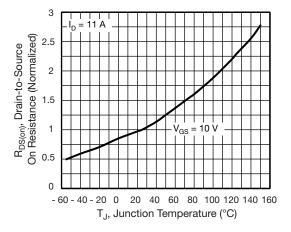


Fig. 4 - Normalized On-Resistance vs. Temperature

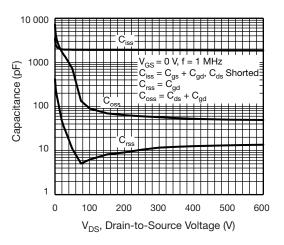


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

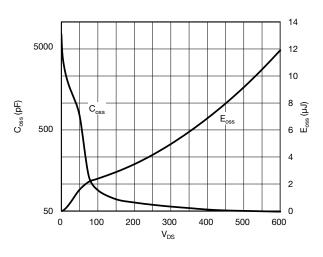


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

S16-1084-Rev. J, 06-Jun-16

**3** 

Document Number: 91471

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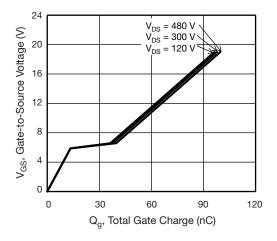


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

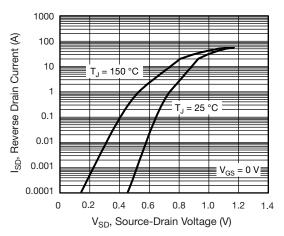


Fig. 8 - Typical Source-Drain Diode Forward Voltage

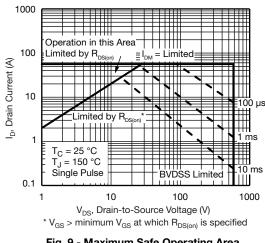


Fig. 9 - Maximum Safe Operating Area

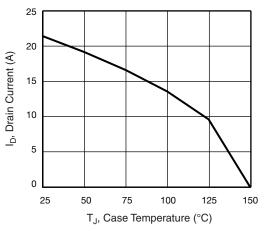


Fig. 10 - Maximum Drain Current vs. Case Temperature

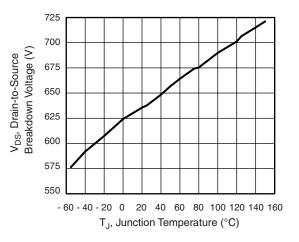


Fig. 11 - Temperature vs. Drain-to-Source Voltage

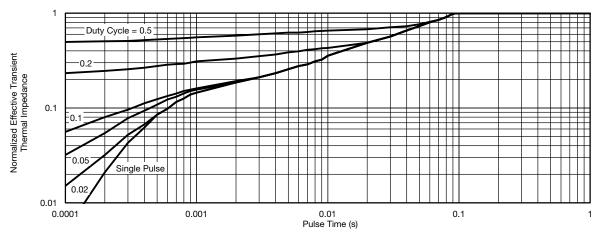
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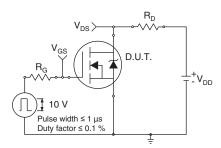


Fig. 13 - Switching Time Test Circuit

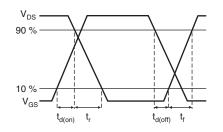


Fig. 14 - Switching Time Waveforms

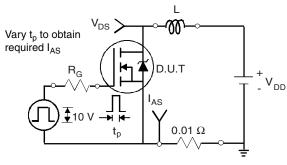


Fig. 15 - Unclamped Inductive Test Circuit

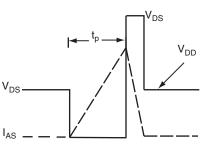


Fig. 16 - Unclamped Inductive Waveforms

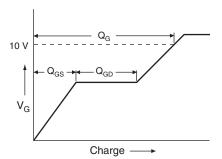


Fig. 17 - Basic Gate Charge Waveform

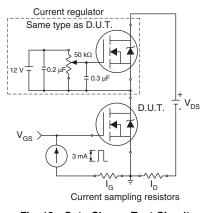


Fig. 18 - Gate Charge Test Circuit

S16-1084-Rev. J, 06-Jun-16

5

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#### Peak Diode Recovery dV/dt Test Circuit

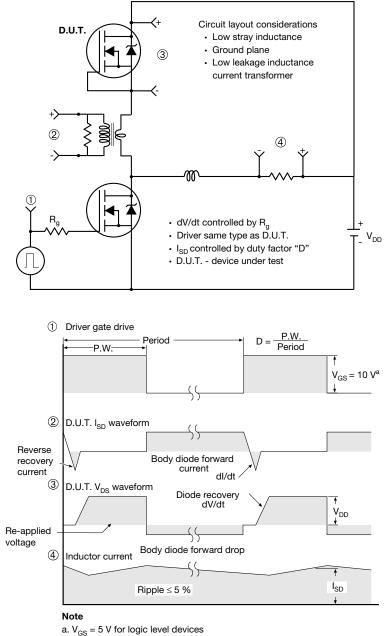


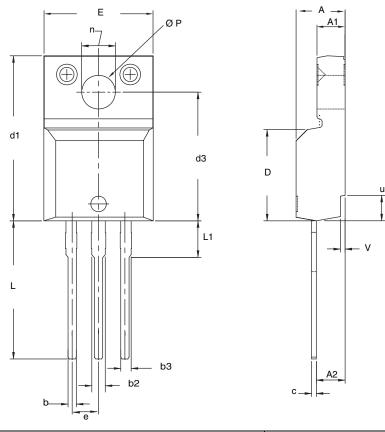
Fig. 19 - For N-Channel

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**Package Information** 

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### **TO-220 FULLPAK (HIGH VOLTAGE)**



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet  $C_{pk} > 1.33$ .

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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